

Title (en)

ELECTRONIC COMPONENT WITH FLEXIBLE CONTACT POINTS AND METHOD FOR THE PRODUCTION THEREOF

Title (de)

ELEKTRONISCHES BAUELEMENT MIT FLEXIBLEN KONTAKTIERUNGSTELLEN UND VERFAHREN ZU DESSEN HERSTELLUNG

Title (fr)

COMPOSANT ELECTRONIQUE POURVU DE POINTS DE CONTACT FLEXIBLES, ET SON PROCEDE DE FONCTIONNEMENT

Publication

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Application

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Priority

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Abstract (en)

[origin: WO0175969A1] The invention relates to an electronic component (2) and a method for the production thereof. The electronic component (2) comprises an electric circuit and a rubber elastic elevation (3). The rubber elastic elevation (3) is made from an insulating rubber elastic material and is arranged on the surface (13) of the electric component (2), having an electric bonding pad (16) on the tip (14) thereof. The rubber elastic elevation (3) also comprises a line path (8) disposed on the sloping side or in the volume thereof between the bonding pad (16) and the electronic circuit.

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IPC 8 full level

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Citation (search report)

See references of WO 0175969A1

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- JP H05160536 A 19930625 - ALPS ELECTRIC CO LTD
- JP H05251455 A 19930928 - TOSHIBA CORP

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